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SONY

1.0 cm (Type 0.39) Active Matrix Color OLED Panel

ECX334AF-6

Description

The ECX334AF is a 1.0 cm (type 0.39) diagonal, 1024 (RGB) × 768 dots active matrix color OLED panel module using single-crystal silicon transistors. This panel incorporates panel driver and logic driver, and realizes small size, light weight and high definition.

(Applications: View finders, head mounted displays, very small monitors, etc.)

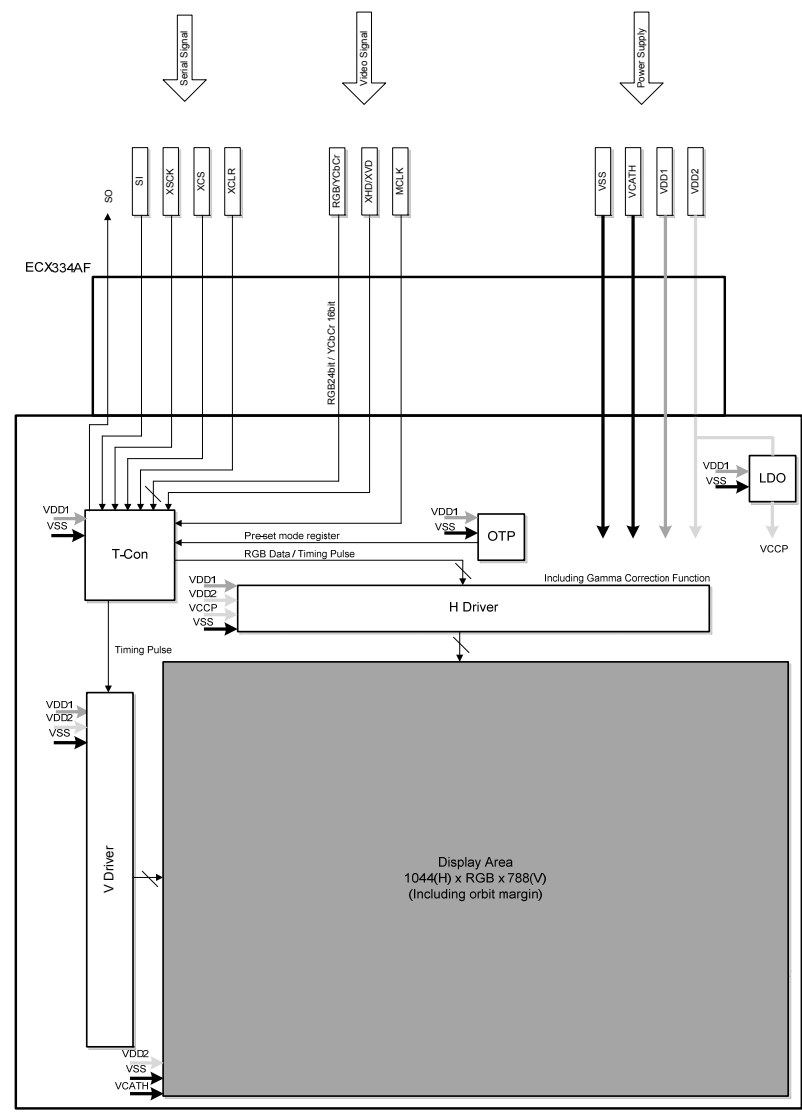
Features

- ◆ Small-size, high-definition-type 0.39 XGA display dots 1024 (RGB) × 768 = 2.38M dots
- ◆ High contrast
- ◆ Wide color reproduction range
- ◆ High-speed response
- ◆ Thin type and light weight
- ◆ Power-saving function
- ◆ Up/down and/or right/left inverse display function
- ◆ Orbit supported
- ◆ Input interface that supports parallel RGB 24-bit and YCbCr 16-bit input

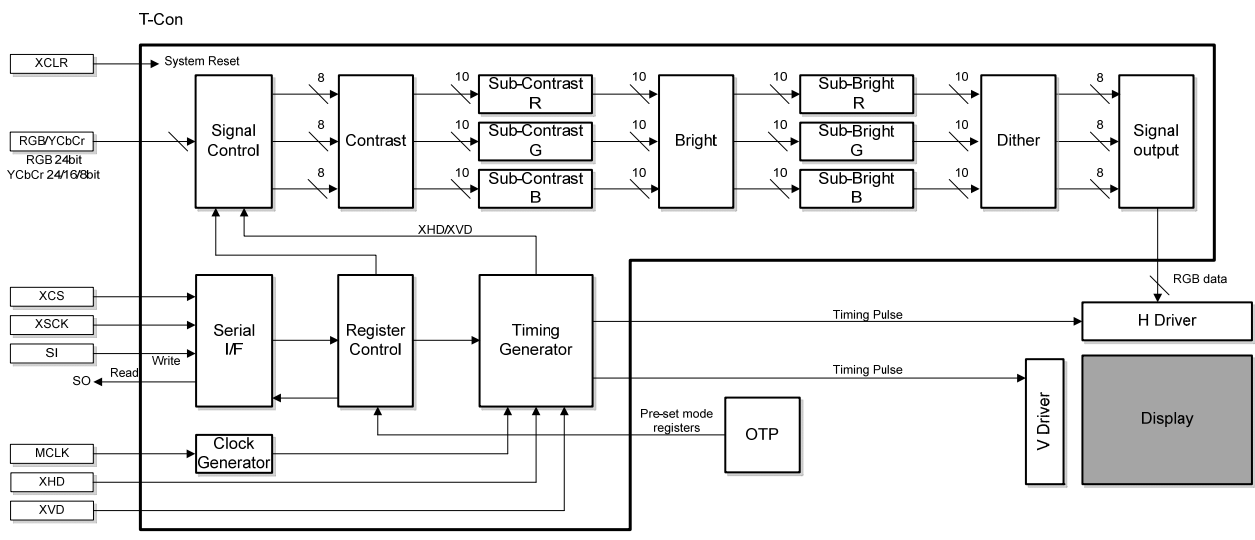
Element Structure

Active matrix color OLED display element with on-chip driver using single-crystal silicon transistors

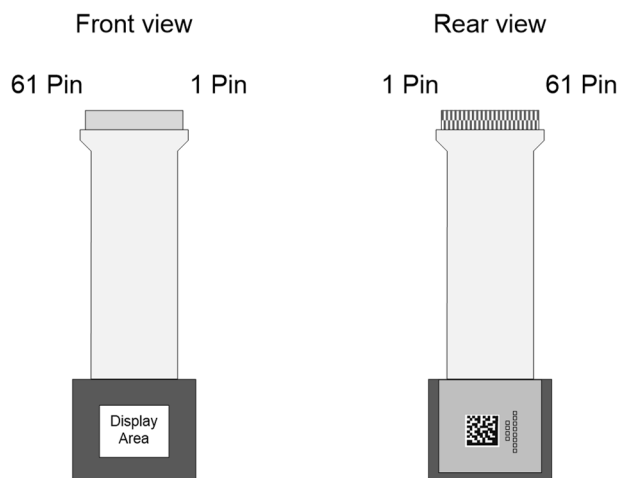
Block Diagram



Details of T-Con



Pin Assignment



Pin Description

Pin No. (connector side)	Symbol	Type	Pin Description	Equivalent circuit
1	TEST	Input	GND	
2	VCCP	Power supply	VCCP power supply	
3	VDD2	Power supply	10V power supply	
4	VSS	Power supply	GND	
5	VSS	Power supply	GND	
6	Vcath	Power supply	EL cathode power supply	
7	VSS	Power supply	GND	
8	VDD1	Power supply	1.8V power supply	
9	MCLK	Input	Clock	*1
10	XHD	Input	Horizontal sync signal (negative polarity)	*1
11	XVD	Input	Vertical sync signal (negative polarity)	*1
12	XCLR	Input	System reset	*2
13	Rin7/ GND	Input	(RGB input mode) Digital R signal/ (YCbCr input mode) GND	*1
14	Rin6/ GND	Input	(RGB input mode) Digital R signal/ (YCbCr input mode) GND	*1
15	Rin5/ GND	Input	(RGB input mode) Digital R signal/ (YCbCr input mode) GND	*1
16	Rin4/ GND	Input	(RGB input mode) Digital R signal/ (YCbCr input mode) GND	*1
17	Rin3/ GND	Input	(RGB input mode) Digital R signal/ (YCbCr input mode) GND	*1
18	Rin2/	Input	(RGB input mode) Digital R signal/	*1

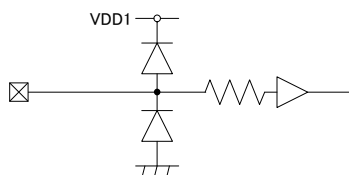
Pin No. (connector side)	Symbol	Type	Pin Description	Equivalent circuit
	GND		(YCbCr input mode) GND	
19	Rin1/ GND	Input	(RGB input mode) Digital R signal/ (YCbCr input mode) GND	*1
20	Rin0/ GND	Input	(RGB input mode) Digital R signal/ (YCbCr input mode) GND	*1
21	Gin7/ Yin7	Input	(RGB input mode) Digital G signal/ (YCbCr input mode) Digital luminance signal	*1
22	Gin6/ Yin6	Input	(RGB input mode) Digital G signal/ (YCbCr input mode) Digital luminance signal	*1
23	Gin5/ Yin5	Input	(RGB input mode) Digital G signal/ (YCbCr input mode) Digital luminance signal	*1
24	Gin4/ Yin4	Input	(RGB input mode) Digital G signal/ (YCbCr input mode) Digital luminance signal	*1
25	Gin3/ Yin3	Input	(RGB input mode) Digital G signal/ (YCbCr input mode) Digital luminance signal	*1
26	Gin2/ Yin2	Input	(RGB input mode) Digital G signal/ (YCbCr input mode) Digital luminance signal	*1
27	Gin1/ Yin1	Input	(RGB input mode) Digital G signal/ (YCbCr input mode) Digital luminance signal	*1
28	Gin0/ Yin0	Input	(RGB input mode) Digital G signal/ (YCbCr input mode) Digital luminance signal	*1
29	VDD 1	Power supply	1.8V power supply	
30	VSS	Power supply	GND	
31	Bin7/ CbCin7	Input	(RGB input mode) Digital B signal/ (YCbCr input mode) Digital luminance signal	*1
32	Bin6/ CbCin6	Input	(RGB input mode) Digital B signal/ (YCbCr input mode) Digital luminance signal	*1
33	Bin5/ CbCin5	Input	(RGB input mode) Digital B signal/ (YCbCr input mode) Digital luminance signal	*1
34	Bin4/ CbCin4	Input	(RGB input mode) Digital B signal/ (YCbCr input mode) Digital luminance signal	*1
35	Bin3/ CbCin3	Input	(RGB input mode) Digital B signal/ (YCbCr input mode) Digital luminance signal	*1
36	Bin2/ CbCin2	Input	(RGB input mode) Digital B signal/ (YCbCr input mode) Digital luminance signal	*1
37	Bin1/ CbCin1	Input	(RGB input mode) Digital B signal/ (YCbCr input mode) Digital luminance signal	*1
38	Bin0/ CbCin0	Input	(RGB input mode) Digital B signal/ (YCbCr input mode) Digital luminance signal	*1
39	TEST (SCAN_MODE)	Input	Test pin (connect to GND)	*3
40	TEST (TEN)	Input	Test pin (connect to VDD1)	*2
41	TEST(PSCNT)	Input	Test pin (connect to GND)	*2
42	XCS	Input	Serial communication Chip select	*2
43	XCLK	Input	Serial communication Serial clock	*2
44	SI	Input	Serial communication Data input	*2
45	SO	Output	Serial communication Data output	*4
46	TEST(DDEN)	Output	Test pin (DD converter enable)	*4

Pin No. (connector side)	Symbol	Type	Pin Description	Equivalent circuit
47	TEST (VFUSE)	Power supply	Test pin (connect to GND)	*5
48	VSS	Power supply	GND	
49	VDD1	Power supply	1.8V power supply	
50	VCAL	Output	Correction voltage output in temperature compensation circuit	*6
51	TEST	Output	Test pin	*6
52	TEST	Output	Test pin	*6
53	VG255	Output	Gamma top reference voltage (255 gray scale)	*6
54	VG0	Output	Gamma bottom reference voltage (0 gray scale)	*6
55	VOFS	Power supply	Vofs voltage	*6
56	Vcath	Power supply	EL cathode power supply	
57	VSS	Power supply	GND	
58	VSS	Power supply	GND	
59	VDD2	Power supply	10V power supply	
60	VCCP	Power supply	VCCP power supply	
61	VSS	Power supply	GND	

Equivalent Circuit

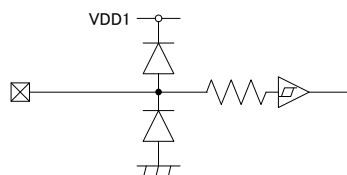
*1

Pin No. 9,10,11 & RGB Data



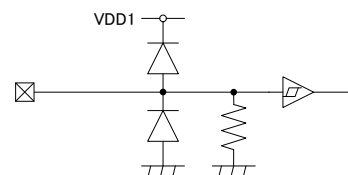
*2(Schmitt)

Pin No. 12,40,41,42,43 & 44



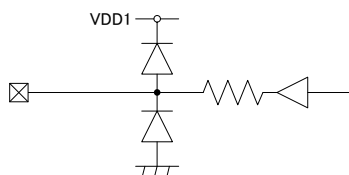
*3(Schmitt)

Pin No. 39



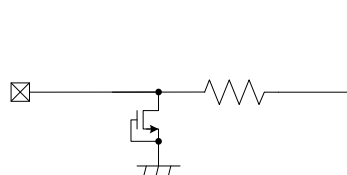
*4

Pin No. 45 & 46



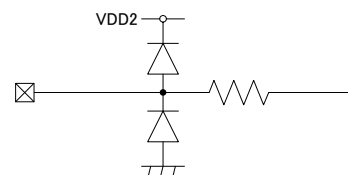
*5

Pin No. 47



*6

Pin No. 50,51,52,53,54 & 55



Absolute Maximum Ratings

Item	Symbol	Min.	Maximum Ratings	Unit
1.8V power supply	VDD1	-0.3	2.0	V
10V power supply	VDD2	-0.3	12.0	V
EL cathode voltage	Vcath	-0.3	0.3	V
Logic input voltage	Vi	-0.3	VDD1+ 0.3	V
Storage temperature	Tpnl	-30	+80	°C

Recommended Operating Conditions

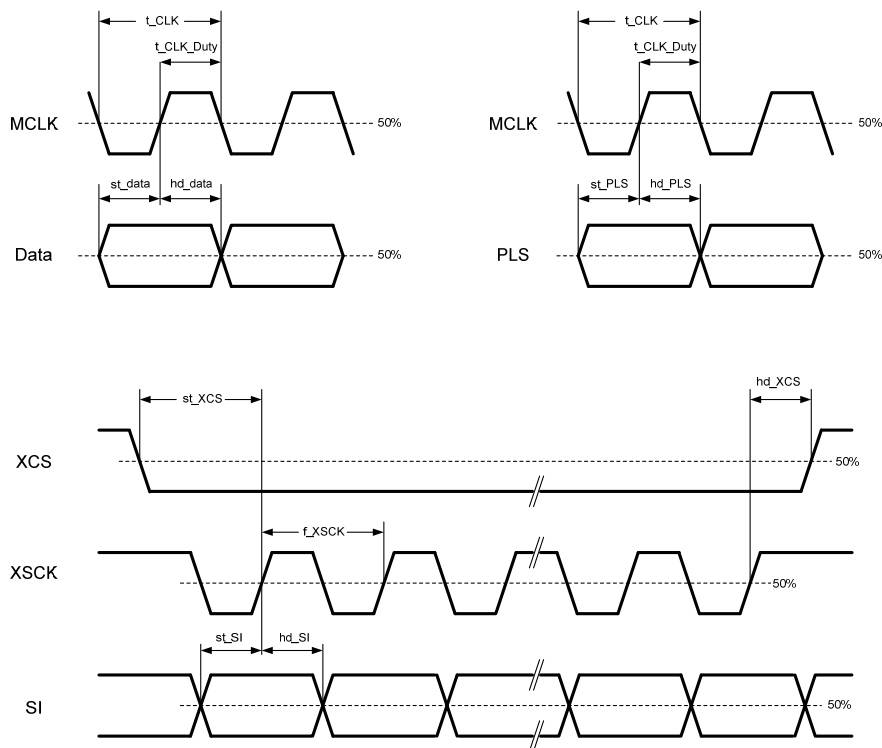
Item	Symbol	Min.	Typ.	Max.	Unit
1.8V power supply	VDD1	1.62	1.8	1.98	V
10V power supply	VDD2	9.7	10.0	10.3	V
EL cathode voltage	Vcath	-0.3	0	0.3	V
Operating temperature range	Tpnl	-10		70	°C

Electrical Characteristics**1. DC Characteristics**

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
High level input voltage	VIH		0.7VDD1		VDD1	V
Low level input voltage	VIL		0		0.3VDD1	V
High level input voltage	Vt+	Schmitt input	0.7VDD1		VDD1	V
Low level input voltage	Vt-	Schmitt input	0		0.3VDD1	V
Vt+ - Vt-	Vhys	Schmitt input		0.50		V
Logic high level output voltage	VOH		VDD1-0.4			V
Logic low level output voltage	VOL				0.4	V

2. AC Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Clock pulse cycle	t_{CLK}		18.3	18.5		ns
Clock duty	t_{CLK_duty}	All mode (54 MHz) common	40	50	60	%
Data setup time	st_Data	$V_i = 1.62$ to 1.98 V	2.5			ns
Data hold time	hd_Data	$V_i = 1.62$ to 1.98 V	1.8			ns
Control pulse setup time	st_PLS	$V_i = 1.62$ to 1.98 V	2.5			ns
Control pulse hold time	hd_PLS	$V_i = 1.62$ to 1.98 V	1.8			ns
XSCK frequency	f_SCLK			0.8	2.5	MHz
XCS setup time	st_XCS		0.4			μ s
XCS hold time	hd_XCS		0.2			μ s
SI setup time	st_SI		0.2			μ s
SI hold time	hd_SI		0.2			μ s



3. Power Consumption

Item	Symbol	Conditions	Typ.			Unit
			300cd/m ²	200cd/m ²	Standby	
VDD1 power consumption	DIDD1	T _{pnl} = 40°C (*)	11			mW
VDD2 power consumption	DIDD2		235	195	2	mW

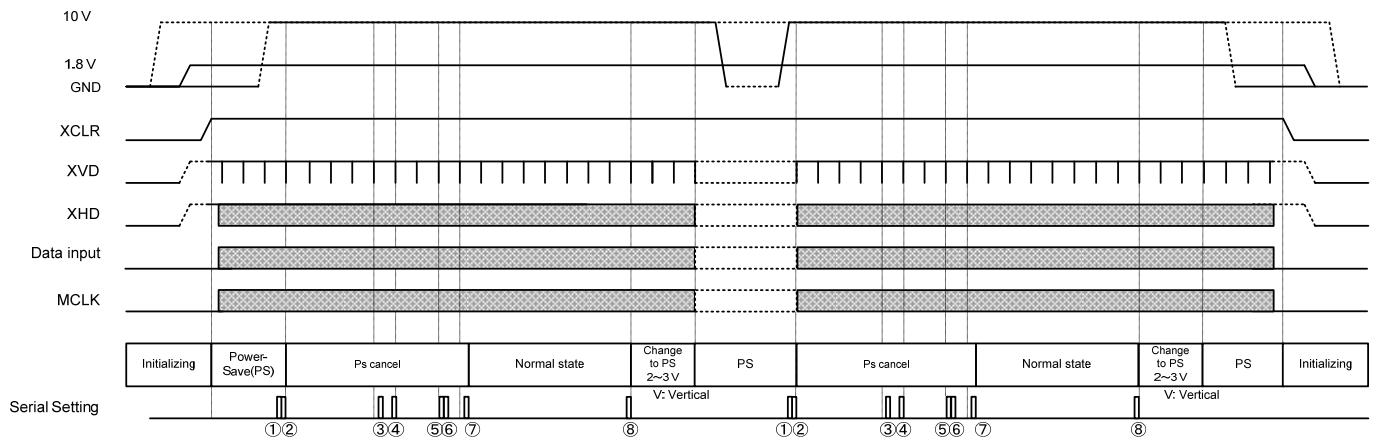
Total	DITTL		246	206	2	mW
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*: All white raster display, clock frequency=54MHz, frame rate=60Hz

Power Supply Sequence

Be sure to follow the power supply sequences noted below to prevent panel damage due to abnormal currents to the panel internal circuits.

1. Sequence Diagram



Serial Setting①		Serial Setting②		Serial Setting③		Serial Setting④		Serial Setting⑤		Serial Setting⑥		Serial Setting⑦		Serial Setting⑧	
Address	Data (Hex)	Address	Data (Hex)	Address	Data (Hex)	Address	Data (Hex)	Address	Data (Hex)	Address	Data (Hex)	Address	Data (Hex)	Address	Data (Hex)
		0x00	0F(*1)											0x00	0E(*2)
0x03	A0											0x03	20		
0x04	5F			0x04	1F										
0x53	02									0x53	00				
0x5B	4F					0x5B	04	0x5B	00						
0x5C	4D					0x5C	04	0x5C	00						

*1: YCbCr(BT601) Input : 8F

*2: YCbCr(BT601) Input : 8E

2. Power On Sequence

- Set XCLR to low and turn on 1.8V power supply, then the panel is initialized.
- 1.8V power supply turned on and allocate more than 1.0msec period and then Set XCLR to high. It turns out Power-Save (PS) mode ON.
- Turned Power-Save mode and allocate more than 10msec period and then perform the serial setting ①
- Set Power-Saving mode OFF (serial setting ②).
- Perform the serial setting ③ later than 4V(Vertical) after serial setting ② completion.
- Perform the serial setting ④ later than 3ms after serial setting ③ completion.
- Perform the serial setting ⑤ later than 2V(Vertical) after serial setting ④ completion.
- Perform the serial setting ⑥ after serial setting ⑤ completion.
- Perform the serial setting ⑦ later than 1V(Vertical) after the serial setting ⑥ completion.

Highly recommend that register refresh would be done in V-blanking period after power on sequence. Minimum interval is 1V period, which is sum of FP and Vsync, BP. Recommended format is burst mode.

3. Power Off Sequence

1. Perform serial setting ⑧ (Power-Save ON) in normal operation period.
2. After Power-Save ON, allocate more than 3V(Vertical) period and then set XCLR to low and turn off 10V power supply.
3. Turn off 1.8V power supply.

* No restriction for sequential order for “1.8V power supply off” and “XCLR to low”, whichever OK.

* 1.8V power supply should be turn off after “XCLR to low”.

* After setting ⑧, allocate more than 3V(Vertical) period and then XVD, XHD, Data, MCLK can be turn off.

Description of Functions

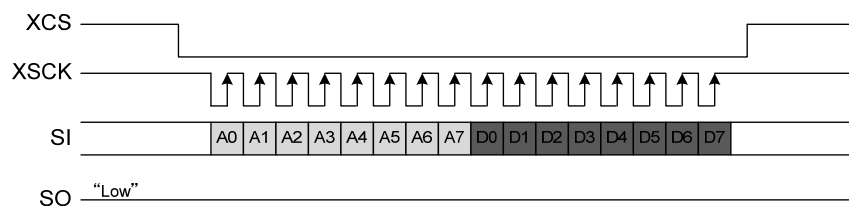
1. Tcon Block

1.1. Serial I/F Transfer Timing

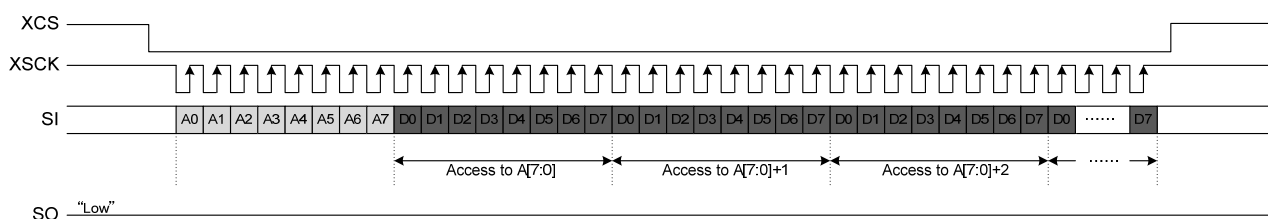
◆ Write

Serial communication (normal / burst transfer, LSB first) is supported for write operation.

Timing is shown below.



Write access normal transfer (LSB First)



Write access burst transfer (LSB First)

◆ Read

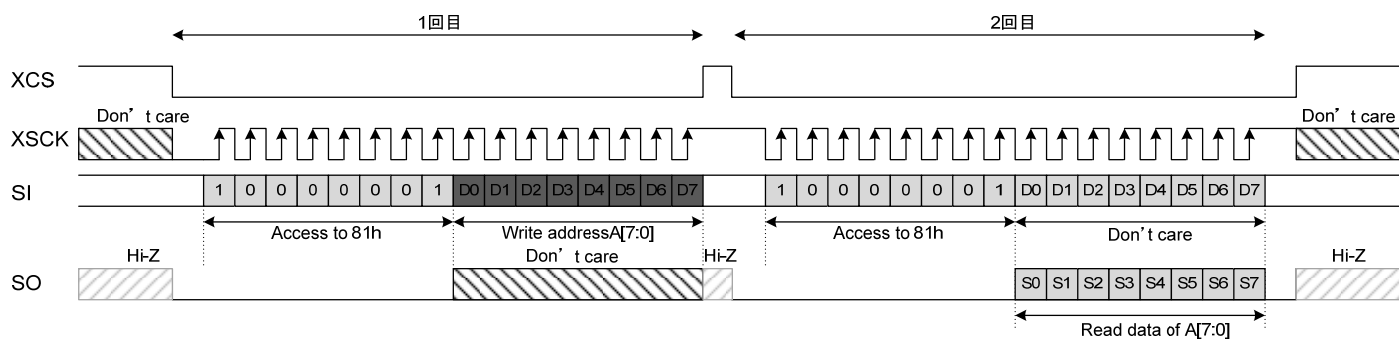
Serial communication (normal transfer, LSB first) is supported for read operation.

Set RD_ON(0x80) to 1, and then perform 2 times serial communication.

1st: Write the address of read data on RD_ADDR (0x81).

2nd: Read data is output from SO (pin no.45) after data access.

Timing is shown below



Read access normal transfer (LSB First)

1.3. Register Map

	Addr.	DATA7	DATA6	DATA5	DATA4	DATA3	DATA2	DATA1	DATA0
0	+0x00	RGB_YCB	YCB_DEC	0	0	DWN	RGT	MCLKPOL	PS0
1	+0x01	VCAL_MON	CALSEL[1:0]		YCB_P	0	0	0	0
2	+0x02	1	1	0	ORBIT_H[4:0]				
3	+0x03	TMPEN	T_SLOPE	DITHER_ON	ORBIT_V[4:0]				
4	+0x04	0	LDOEXT	0	1	1	1	1	1
5	+0x05	0	0	0	0	1	LUMINANCE[2:0]		
6	+0x06	0	0	0	0	0	0	0	0
7	+0x07	0	0	0	0	0	0	0	0
8	+0x08	0	0	0	0	0	OTPCALDAC_REGDIS	0	OTPDG_REGDIS
9	+0x09	0	1	0	1	0	1	1	0
A	+0x0A	0	0	0	DRGAMMA32[4:0]				
B	+0x0B	0	0	0	DRGAMMA64[4:0]				
C	+0x0C	0	0	0	DRGAMMA128[4:0]				
D	+0x0D	0	0	0	DRGAMMA256[4:0]				
E	+0x0E	0	0	0	DGGAMMA32[4:0]				
F	+0x0F	0	0	0	DGGAMMA64[4:0]				
10	+0x10	0	0	0	DBGAMMA32[4:0]				
11	+0x11	0	0	0	DBGAMMA64[4:0]				
12	+0x12	0	0	0	DBGAMMA128[4:0]				
13	+0x13	0	0	0	DBGAMMA256[4:0]				
14	+0x14	CONT[7:0]							
15	+0x15	CONT[8]	RCONT[6:0]						
16	+0x16	0	GCONT[6:0]						
17	+0x17	0	BCONT[6:0]						
18	+0x18	BRT[7:0]							
19	+0x19	0	RBRT[6:0]						
1A	+0x1A	0	GBRT[6:0]						
1B	+0x1B	0	BBRT[6:0]						
1C	+0x1C	0	0	0	LDOSEL[4:0]				
1D	+0x1D	CALDAC[7:0]							
1E	+0x1E	0	1	0	0	0	0	0	0
1F	+0x1F	0	0	0	1	0	0	0	1
20	+0x20	H_ACT_U[7:0]							
21	+0x21	H_ACT_U[8]	0	V_ACT_D[9:8]		0	H_ACT_D[10:8]		
22	+0x22	H_ACT_D[7:0]							
23	+0x23	V_ACT_U[7:0]							
24	+0x24	V_ACT_D[7:0]							
25	+0x25	0	0	0	0	0	0	0	0
26	+0x26	0	0	0	0	0	0	0	0
27	+0x27	0	0	0	0	0	0	0	0
28	+0x28	0	DE_D[10:8]			0	DE_U[10:8]		
29	+0x29	DE_U[7:0]							
2A	+0x2A	DE_D[7:0]							
2B	+0x2B	0	0	0	0	0	0	0	0
2C	+0x2C	0	0	0	0	0	0	0	0
2D	+0x2D	0	0	WSST1_D[9:8]		0	0	WSST1_U[9:8]	
2E	+0x2E	WSST1_U[7:0]							
2F	+0x2F	WSST1_D[7:0]							
30	+0x30	0	0	WSST2_D[9:8]		0	0	WSST2_U[9:8]	
31	+0x31	WSST2_U[7:0]							
32	+0x32	WSST2_D[7:0]							
33	+0x33	WSEN1_U[7:0]							
34	+0x34	WSEN1_W[7:0]							
35	+0x35	0	0	0	0	0	WSEN2_U[10:8]		
36	+0x36	WSEN2_U[7:0]							
37	+0x37	WSEN2_W[7:0]							

38	+0x38	WSEN3_U[7:0]							
39	+0x39	WSEN3_W[7:0]							
3A	+0x3A	DSEN_U[7:0]							
3B	+0x3B	0	0	0	0	0	DSEN_W[10:8]		
3C	+0x3C	DSEN_W[7:0]							
3D	+0x3D	0	0	VCK_W[9:8]		0	0	VCK_U[9:8]	
3E	+0x3E	VCK_U[7:0]							
3F	+0x3F	VCK_W[7:0]							
40	+0x40	0	0	0	0	0	0	SIGSELREF_U[9:8]	
41	+0x41	SIGSELREF_U[7:0]							
42	+0x42	SIGSELREF_W[7:0]							
43	+0x43	0	0	0	0	SIGSELOFS_U[3:0]			
44	+0x44	SIGSELOFS_W[7:0]							
45	+0x45	0	0	SGISEL_W[9:8]		SIGSEL_U[3:0]			
46	+0x46	SIGSEL_W[7:0]							
47	+0x47	0	0	0	0	0	0	SELREF_U[9:8]	
48	+0x48	SELREF_U[7:0]							
49	+0x49	SELREF_W[7:0]							
4A	+0x4A	SELOFS_U[7:0]							
4B	+0x4B	SELOFS_W[7:0]							
4C	+0x4C	0	0	SEL_W[9:8]		0	0	SEL_U[9:8]	
4D	+0x4D	SEL_U[7:0]							
4E	+0x4E	SEL_W[7:0]							
4F	+0x4F	0	0	0	0	0	0	0	0
50	+0x50	0	0	0	0	0	0	0	0
51	+0x51	0	0	0	0	0	0	0	0
52	+0x52	0	0	0	0	0	0	0	0
53	+0x53	120MODE	0	0	0	0	0	0	0
54	+0x54	1	1	1	0	0	1	1	1
55	+0x55	0	0	0	0	0	0	0	0
56	+0x56	0	0	0	0	0	0	0	0
57	+0x57	0	0	0	0	0	0	0	0
58	+0x58	0	0	0	0	0	0	0	0
59	+0x59	0	0	0	0	0	0	0	0
5A	+0x5A	0	0	0	0	0	0	0	0
5B	+0x5B	0	0	0	0	0	0	0	0
5C	+0x5C	0	0	0	0	0	0	0	0
5D	+0x5D	0	0	0	0	0	0	0	0
5E	+0x5E	0	0	0	0	0	0	0	0
5F	+0x5F	0	0	0	0	0	0	0	0
60	+0x60	0	0	0	0	0	0	0	0
61	+0x61	0	0	0	0	0	0	0	0
62	+0x62	0	0	0	0	0	0	0	0
63	+0x63	0	0	0	0	0	0	0	0
64	+0x64	0	0	0	0	0	0	0	0
65	+0x65	0	0	0	0	0	0	0	0
66	+0x66	0	0	0	0	0	0	0	0
67	+0x67	0	0	1	1	0	0	0	0
80	+0x80	0	0	0	0	0	0	0	RD_ON
81	0x81	RD_ADDR[7:0]							

1.4. Description of Registers

Register name	Number of bits	V sync	Function
PS0	1		Power Save Mode 0: Power Save on 1: Power Save off
MCLKPOL	1		MCLK polarity switching 0: Negative polarity 1: Positive polarity
RGT	1		0: Left scan 1: Right scan
DWN	1		0: Upper scan 1: Lower scan
YCB_DEC	1		YCbCr/YPbPr conversion switching 0: YCbCr (conforms to BT601) 1: YPbPr (conforms to BT709)
RGB_YCB	1		RGB/YCbCr input format selection 0: RGB 1: YCbCr/YPbPr
YCB_P	1	○	YCbCr/YPbPr input pattern switching 0: Cb/Pb First (Mode A) 1: Cr/Pr First (Mode B)
CALSEL	2		VCAL output selection 01: V1 output 10: V2 output 11: VOUT attenuate output ($V_{GAM4} \times 0.25[V]$)
VCAL_MON	1		Temperature sensing circuit monitoring 0: Invalid 1: Valid
ORBIT_H	5	○	Horizontal orbit adjustment -10 to 0 to +10, Default: 0x00
ORBIT_V	5	○	Vertical orbit adjustment -10 to 0 to +10, Default: 0x00
DITHERON	1		Dithering On/Off 0: Dithering Off 1: Dithering On
LDOEXT	1		LDO external / internal selection 0: Internal (normally fixed to 0) 1: External
LUMINANCE	3		Luminance and white chromaticity preset mode selection
OTPDG_REGDIS	1		White chromaticity adjustment 0: Preset mode valid 1: Preset mode invalid (CONT/BRT adjustment)
OTPCALDAC_REGDIS	1		Luminance adjustment 0: Preset mode valid 1: Preset mode invalid (CALDAC adjustment)
DRGAMMA32	5		Red 32 gray scale chromaticity adjustment
DRGAMMA64	5		Red 64 gray scale chromaticity adjustment
DRGAMMA128	5		Red 128 gray scale chromaticity adjustment
DRGAMMA256	5		Red 256 gray scale chromaticity adjustment
DGGAMMA32	5		Green 32 gray scale chromaticity adjustment
DGGAMMA64	5		Green 64 gray scale chromaticity adjustment

Register name	Number of bits	V sync	Function
DBGAMMA32	5		Blue 32 gray scale chromaticity adjustment
DBGAMMA64	5		Blue 64 gray scale chromaticity adjustment
DBGAMMA128	5		Blue 128 gray scale chromaticity adjustment
DBGAMMA256	5		Blue 256 gray scale chromaticity adjustment
CONT	9		Contrast adjustment
RCONT	7		R sub-contrast adjustment
GCONT	7		G sub-contrast adjustment
BCONT	7		B sub-contrast adjustment
BRT	8		Brightness adjustment
RBRT	7		R sub-brightness adjustment
GBRT	7		G sub-brightness adjustment
BBRT	7		B sub-brightness adjustment
LDOSSEL	5		LDO output voltage adjustment
CALDAC	5		Luminance adjustment setting 7mV/step
H_ACT_U	8		Input signal exchange position
H_ACT_D	11		Input signal exchange position
V_ACT_U	8		Input signal exchange position
V_ACT_D	10		Input signal exchange position
DE_U	11		Timing setting register
DE_D	11		Timing setting register
WSST1_U	10		Timing setting register
WSST1_D	10		Timing setting register
WSST2_U	10		Timing setting register
WSST2_D	10		Timing setting register
WSEN1_U	8		Timing setting register
WSEN1_W	8		Timing setting register
WSEN2_U	11		Timing setting register
WSEN2_W	8		Timing setting register
WSEN3_U	8		Timing setting register
WSEN3_W	8		Timing setting register
DESN_U	8		Timing setting register
DSEN_W	11		Timing setting register
VCK_U	10		Timing setting register
VCK_W	10		Timing setting register
SIGSELREF_U	10		Timing setting register

Register name	Number of bits	V sync	Function
SIGSELREF_W	8		Timing setting register
SIGSELOFS_U	4		Timing setting register
SIGSELOFS_W	8		Timing setting register
SIGSEL_U	4		Timing setting register
SIGSEL_W	10		Timing setting register
SELREF_U	10		Timing setting register
SELREF_W	8		Timing setting register
SELOFS_U	8		Timing setting register
SELOFS_W	8		Timing setting register
SEL_U	10		Timing setting register
SEL_W	10		Timing setting register
120MODE	1		120Hz mode
RD_ON	1		Register read 0: Invalid 1: Valid
RD_ADDR	8		Register read address setting

2. Video Signal Transfer Format

Set the registers appropriately for the video signal transfer format according to the table below.

◆Register Settings

Address	Register name	Number of bits	Function
0x00h	RGB_YCB	1	Selection of RGB / YCbCr (YPbPr) format 0: RGB (default) 1: YCbCr and YPbPr
0x00h	YCB_DEC	1	Selection of YCbCr / YPbPr conversion 0: YCbCr (BT. 601) (default) 1: YPbPr (BT. 709)
0x01h	YCB_P	1	Selection of YCbCr (YPbPr) input pattern 0: Cb and Pb first (default) 1: Cr and Pr first

◆Register settings for each video signal transfer formats when YCB_DEC=0.

*Cb and Cr are replaced by Pb and Pr respectively when YCB_DEC=1.

Register Setting		Video signal transfer format
RGB_YCB	YCB_P	
0	—	
1	0	
	1	

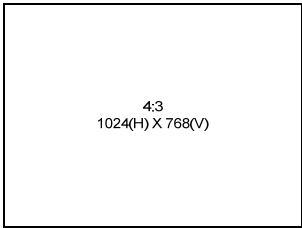
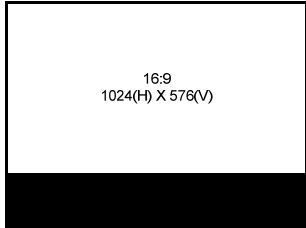
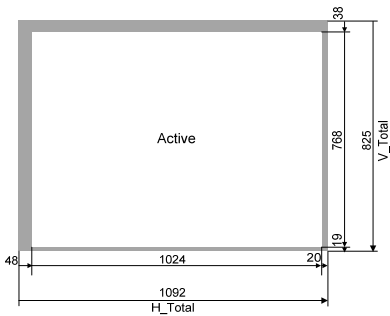
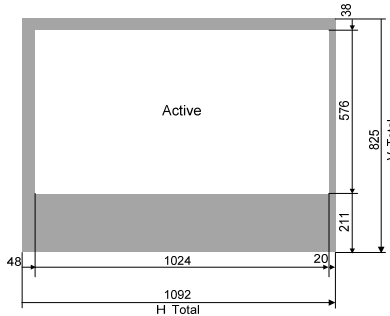
3. Input Signal Format and Timing Settings

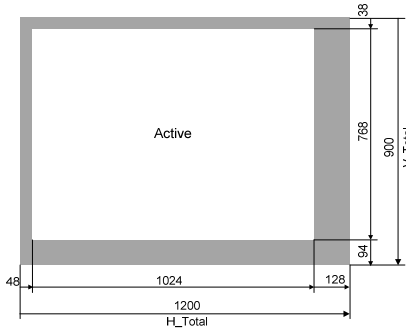
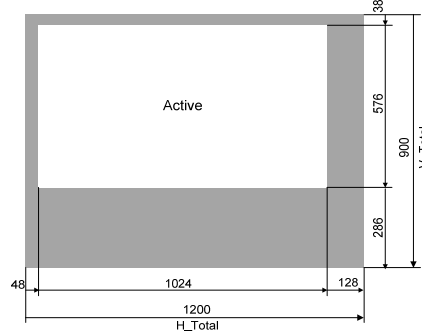
Set the panel timing in accordance with the input signal format.

◆Register Settings

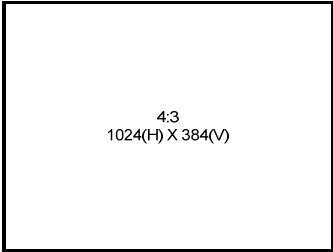
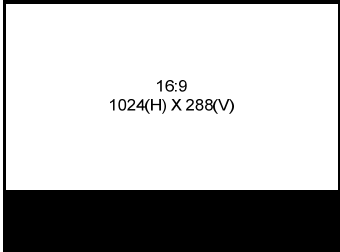
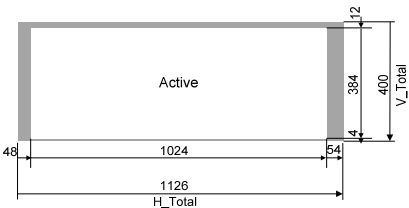
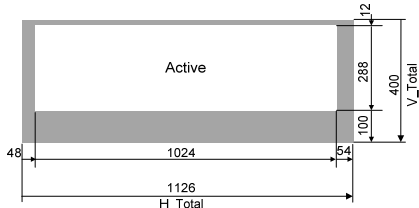
Address	Register name	Bits	Function
0x20h 0x4Eh	H_ACT_U SEL_W		Timing setting registers. Should be set appropriately for the input signal data format. Setting values are separately presented.

◆Panel Display Modes and Input Supported Formats

Panel Display Mode		①4:3 59.94Hz Frame Rate 	②16:9 59.94Hz Frame Rate 
Input Supported Format			
Active	H	1024	1024
	V	768	576
Total	H	1092	1092
	V	825	825
FP	H	20	20
	V	19	211
SYNC	H	16	16
	V	6	6
BP	H	32	32
	V	32	32
BP+SYNC	H	48	48
	V	38	38
fv	Hz	59.94	59.94
Th	μs	20.2	20.2
Clock	MHz	54	54

Panel Display Mode		③4:3 50Hz Frame Rate	④16:9 59.94Hz Frame Rate
		4:3 1024(H) X 768(V)	16:9 1024(H) X 576(V)
Input Supported Format			
Active	H	1024	1024
	V	768	576
Total	H	1200	1200
	V	900	900
FP	H	128	128
	V	94	286
SYNC	H	16	16
	V	6	6
BP	H	32	32
	V	32	32
BP+SYNC	H	48	48
	V	38	38
fv	Hz	50	50
Th	μs	22.2	22.2
Clock	MHz	54	54

Panel Display mode		⑤4:3 119.88Hz Frame Rate	⑥16:9 119.88Hz Frame Rate

			
			
Input Supported Format			
Active	H	1024	1024
	V	384	288
Total	H	1126	1126
	V	400	400
FP	H	54	54
	V	4	100
SYNC	H	16	16
	V	1	1
BP	H	32	32
	V	11	11
BP+SYNC	H	48	48
	V	12	12
f _v	Hz	119.88	119.88
Th	μs	20.9	20.9
Clock	MHz	53.99	53.99

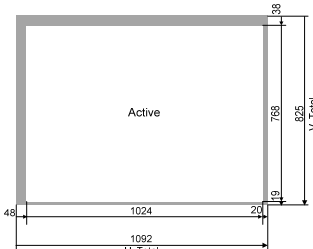
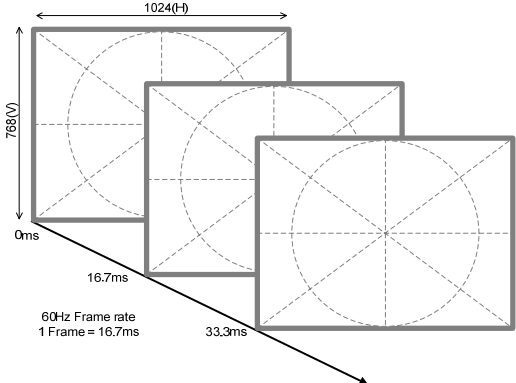
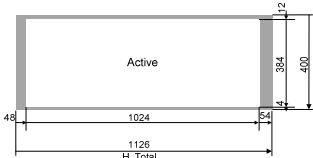
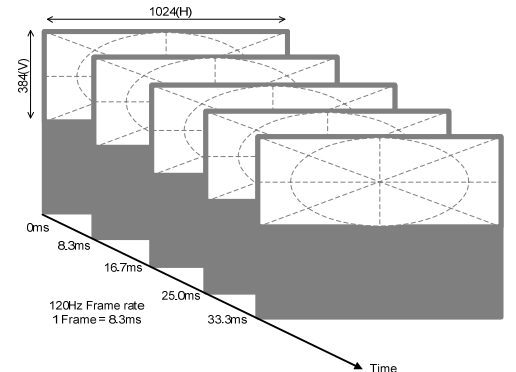
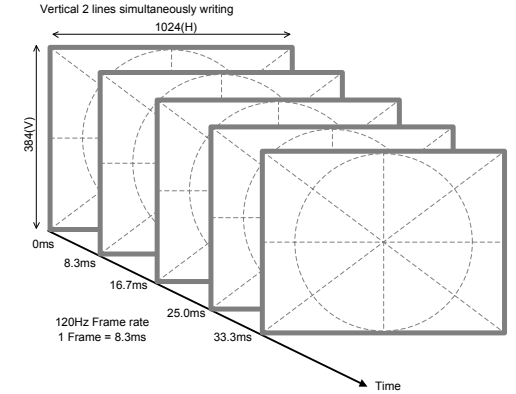
4. 120Hz mode

In order to reduce latency and to alleviate motion-blur effect, there is 120Hz mode in this panel module. With this 120Hz mode, it is available to display as 120Hz refresh rate. In this case, vertical resolution should be half of full scan lines because writing 2line simultaneously with same data. Please refer input format ⑤ and ⑥ in table below.

◆Register setting

Address	Register	Bit	Function
0x53h	120MODE	1	120Hz mode 0: Off 1: On

◆Input format and display image

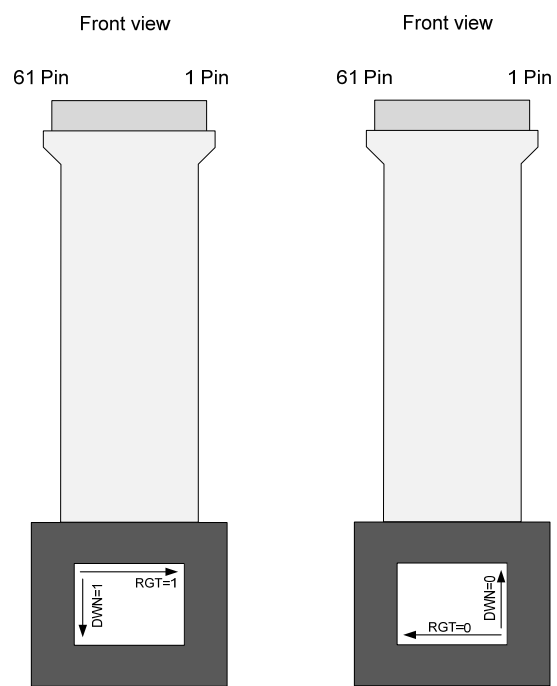
Input format	120MODE	Display image
① 1024 x 768 59.94Hz 	0:Off	
⑤ 1024 x 384 119.88Hz 	0:Off	
	1:On	

5. Up/down and/or Right/left Inversion Function

Up/down and right/left inverse display of the panel are set by the registers RGT and DWN, respectively.

◆Register Settings

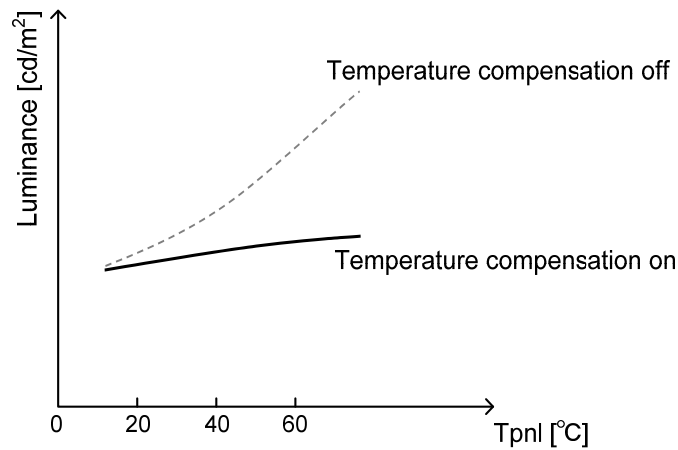
Address	Register name	Number of bits	Function
0x00h	RGT	1	0: Left scan 1: Right scan
0x00h	DWN	1	0: Upper scan 1: Lower scan



6. Luminance Temperature Compensation Function

Organic EL panels have characteristics such that the luminance changes according to the temperature.

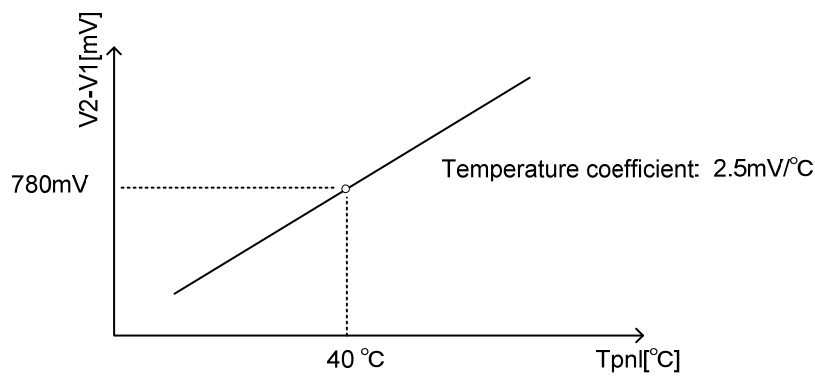
This product has a function that compensates the temperature dependence of the panel luminance.



◆Method of Checking the Panel Temperature

The temperature sensor output voltage can be output from VCAL (output pin 50).

Set the register VCAL_MON to 1: valid, set the register CALSEL as noted above, and read the V1 and V2 outputs. The temperature can be calculated by subtracting V1 from V2.



◆Register Settings

Address	Register name	Number of bits	Function
0x01h	VCAL_MON	1	Temperature sensor monitoring 0: Invalid 1: Valid
0x01h	CALSEL[1:0]	2	VCAL output selection 01: V1 output 10: V2 output 11: VOUT attenuate output (TBD)

7. Luminance Adjustment Function

This function adjusts the gamma top voltage according to the register CALDAC setting to adjust the luminance.

◆Register Settings

Address	Register name	Number of bits	Function
0×1Dh	CALDAC[7:0]	8	Luminance adjustment setting value: 1 to 255 (in decimal notation)

8. White Balance Adjustment Function

8.1. Contrast/Sub-contrast

This function sets the contrast (gain) of the input signal. RGB simultaneous adjustment and R, G and B separate adjustment can be set.

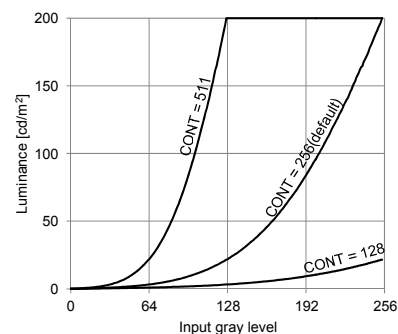
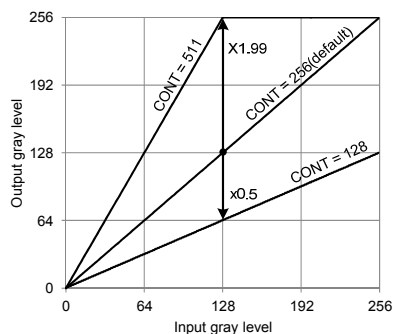
◆ Register Settings

Address	Register name	Number of bits	Function
0x14h, 0x15h	CONT	9	To RGB input signal, $\times 0 \dots \times 1$ (Default) $\dots \times 1.99$
0x15h	RCONT	7	Sets R relative to CONT to $\times 0.75 \dots \times 1$ (Default) $\dots \times 1.24$
0x16h	GCONT	7	Sets G relative to CONT to $\times 0.75 \dots \times 1$ (Default) $\dots \times 1.24$
0x17h	BCONT	7	Sets B relative to CONT to $\times 0.75 \dots \times 1$ (Default) $\dots \times 1.24$

◆ Contrast Adjustment

R, G and B are adjusted simultaneously relative to the input signal using the register CONT. The setting value is 0 to 511 (decimal notation).

CONT setting value	0	...	128	...	256 (Default)	...	384	...	511
Gain (to input)	$\times 0$	...	$\times 0.5$	...	$\times 1$	...	$\times 1.5$	...	$\times 1.99$

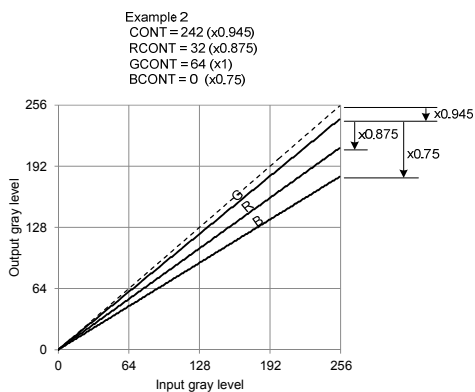
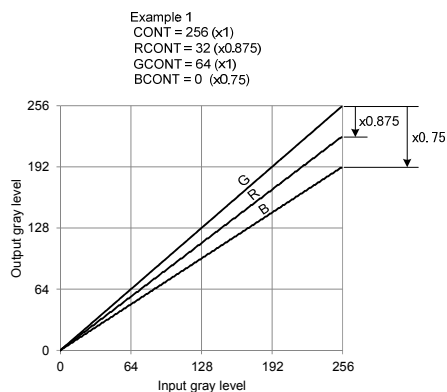


◆ Sub Contrast Adjustment

R, G and B are adjusted separately using the registers RCONT, GCONT and BCONT, respectively.

The R, G and B gains can be set separately relative to the main CONT setting. The setting range is 0 to 127 (decimal notation).

R/G/BCONT setting value	0	...	32	...	64 (Default)	...	96	...	127
Gain (to CONT)	$\times 0.75$	...	$\times 0.875$	...	$\times 1$	...	$\times 1.125$	...	$\times 1.24$



8.2. Bright/Sub Bright

This sets the brightness level of the input signal. RGB simultaneous adjustment and R, G and B separate adjustment can be set.

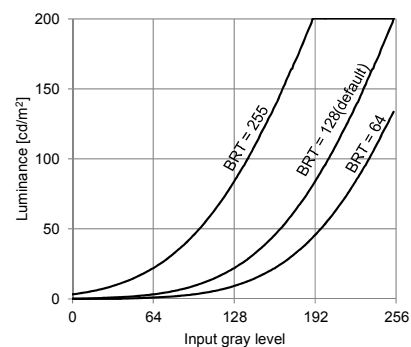
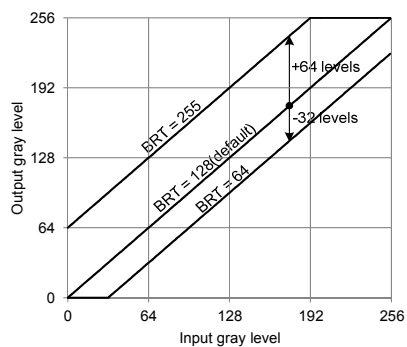
◆Register Settings

Address	Register name	Number of bits	Function
0x18h	BRT	8	To RGB input signal, -64 ... 0 (Default) ... +63 gradations
0x19h	RBRT	7	Sets R relative to BRT to -32 ... 0 (Default) ... +31 gradations
0x1Ah	GBRT	7	Sets G relative to BRT to -32 ... 0 (Default) ... +31 gradations
0x1Bh	BBRT	7	Sets B relative to BRT to -32 ... 0 (Default) ... +31 gradations

◆Brightness Adjustment

R, G and B are adjusted simultaneously relative to the input signal using register BRT. The setting value is 0 to 255 (decimal notation).

BRT setting value	0	...	64	...	128(Default)	...	192	...	255
Output gradations (to input)	-64	...	-32	...	0	...	+32	...	+63

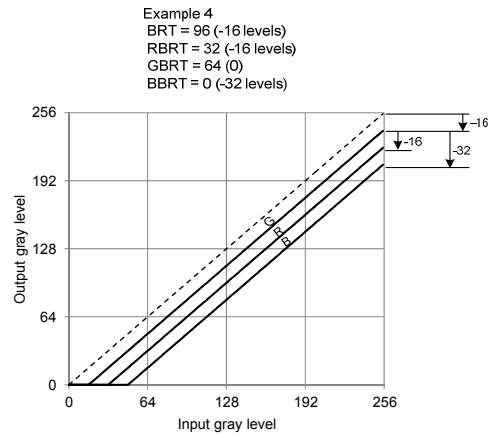
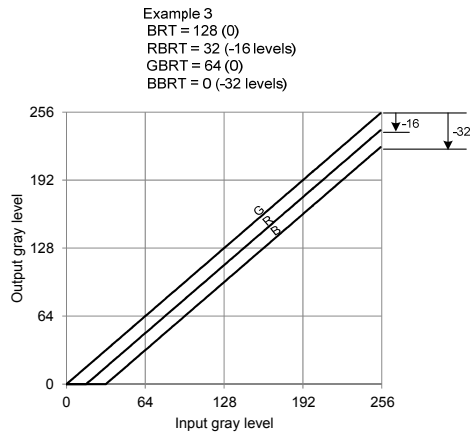


◆Sub Brightness Adjustment

R, G and B are adjusted separately using registers RBRT, GBRT and BBRT, respectively.

The R, G and B adjustments can be set separately relative to the main BRT setting. The setting range is 0 to 127 (decimal notation).

R/G/BBRT setting value	0	...	32	...	64(Default)	...	96	...	127
Output gradations (to BRT)	-32	...	-16	...	0	...	+16	...	+31



9. Luminance and White Balance Preset Mode

This product has 5 luminance and white balance preset modes.

By selecting the mode according to the register LUMINNACE, the luminance and the white chromaticity are adjusted to preset value.

◆Register Settings

Address	Register name	Number of bits	Function
0x08h	OTPCALDAC_REGDIS	1	Luminance adjustment 0: Preset mode valid 1: Preset mode invalid (CALDAC adjustment)
0x08h	OTPDG_REGDIS	1	White chromaticity adjustment 0: Preset mode valid 1: Preset mode invalid (CONT/BRT adjustment)
0x05h	LUMINANCE[2:0]	3	Luminance and white chromaticity preset mode selection 0: 200cd/m ² , (0.31,0.31) 3: 300cd/m ² , (0.31,0.31)

10. Dithering Function

This function expresses simulated gradations between the original gradations by using FRC.

This is used to interpolate gradations that decrease due to contrast or brightness adjustment.

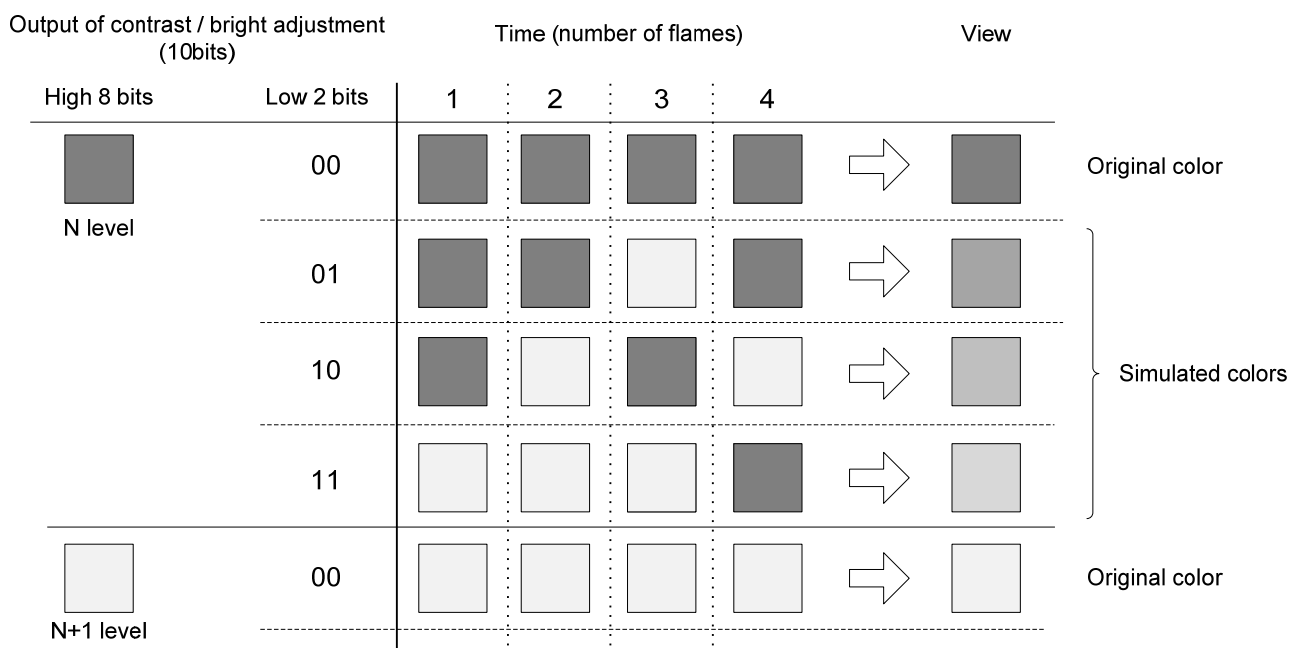
◆Register Settings

Address	Register name	Number of bits	Function
0x03h	DITHERON	1	Dithering processing 0: Off 1: On

10.1. FRC (Frame Rate Control)

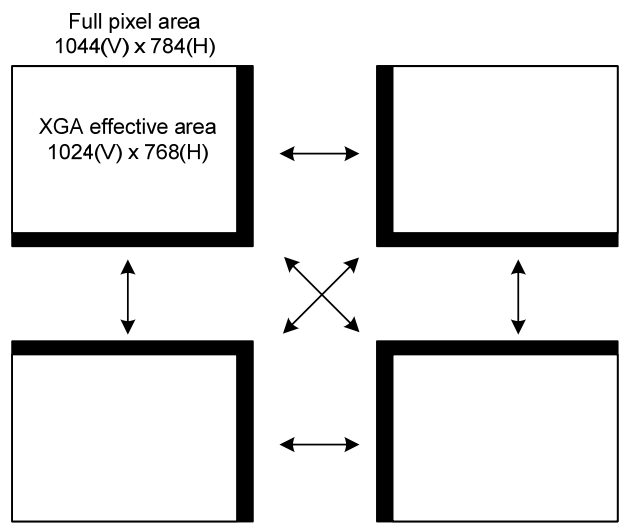
Simulated colors are expressed making use of frame rate and image lag effect of human eyes. When two colors are switching alternately in high-speed, it looks an intermediate color for human eyes. Three simulated colors can be added to original colors by changing data in 4-frame cycle making use of this property (2 bit FRC).

FRC simulated color image when noticing arbitral one pixel is shown below.



11. Orbit Function

The image data start position can be changed. This enables reducing of the noticeability of local drops in luminance.



◆Register Settings

Address	Register name	Number of bits	Function
0x02h	ORBIT_H[4:0]	5	Horizontal orbit adjustment -10 to 0 to +10, Default: 0
0x03h	ORBIT_V[4:0]	5	Vertical orbit adjustment -10 to 0 to +10, Default: 0

11.1. Horizontal Display Position Shift

The display start position is changed by the register ORBIT_H. The variable range is ± 10 pixels.

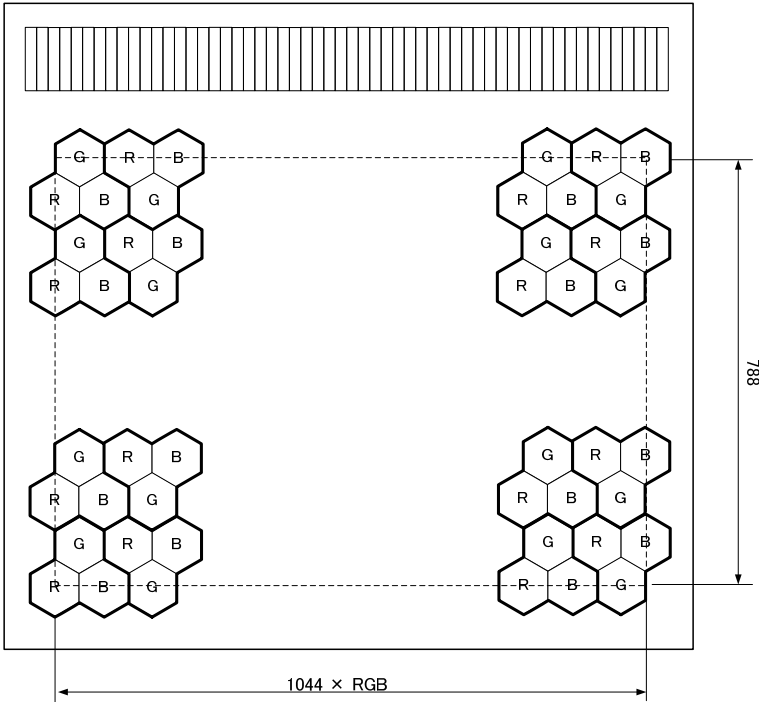
ORBIT_H setting value	-10	...	-1	0 (Default)	1	...	10
Number of pixels shifted	Leftward 10-pixel	...	Leftward 1-pixel	Center	Rightward 1-pixel	...	Rightward 10-pixel

11.2. Vertical Display Position Shift

The display start position is changed by the register ORBIT_V. The variable range is ± 10 pixels.

ORBIT_V setting value	-10	...	-1	0 (Default)	1	...	10
Number of pixels shifted	Upward 10-pixels	...	Upward 1-pixel	Center	Downward 1-pixel	...	Downward 10-pixel

Pixel Array



Optical Characteristics

1. Optical Characteristics

Item		Symbol	Measurement Method	Min.	Typ.	Max.	Unit
Luminance	Mode 0	L0	1	170	200	230	Cd/m ²
	Mode 3	L3	1	255	300	345	Cd/m ²
Contrast		CR	1	10,000	—	—	
Chromaticity	W (L0 & L3)	x	1	0.298	0.310	0.322	CIE
		y	1	0.298	0.310	0.322	CIE
	R	x	1	0.635	0.655	0.675	CIE
		y	1	0.310	0.330	0.350	CIE
	G	x	1	0.255	0.275	0.295	CIE
		y	1	0.625	0.645	0.665	CIE
	B	x	1	0.127	0.147	0.167	CIE
		y	1	0.045	0.065	0.085	CIE

Drive conditions:

OTPDG_REGDIS=0、OTPCALDAC_REGDIS=0,
LUMINANCE=0 (Mode 0), 3 (Mode 3)

2. Measurement System • Measurement Method 1

The luminance and chromaticity are measured in Measurement System A shown below.

Measurement temperature: $T_{pnl} = 40^{\circ}\text{C}$

Measurement point: One point on the screen center

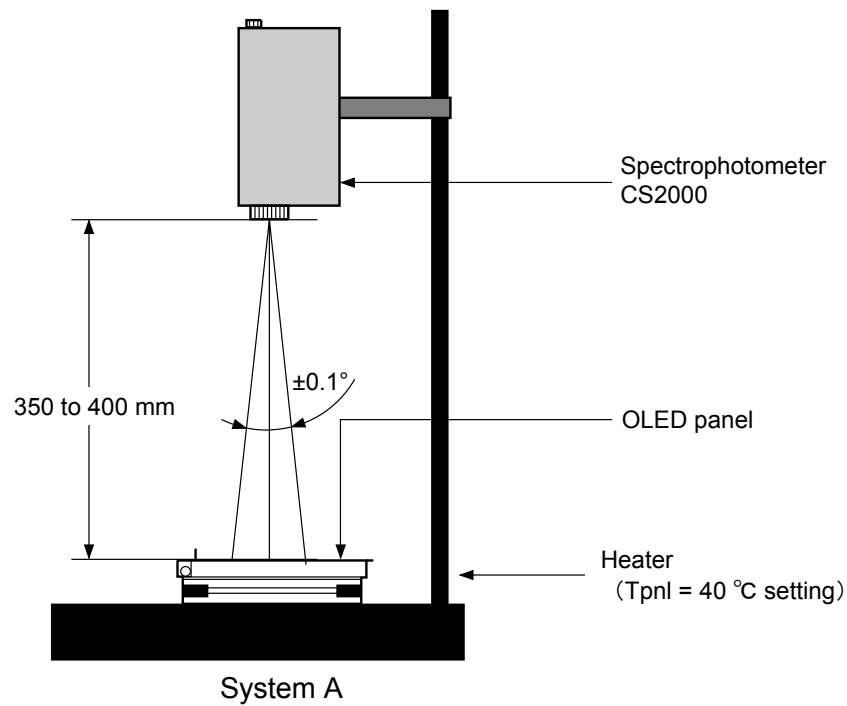
All white display: All RGB signal data is set to High.

All black display: All RGB signal data is set to Low.

Luminance and chromaticity: Measure the luminance and chromaticity in all white display in Measurement System A.

Contrast: Measure the luminance in all white display (@ Mode3: 300cd/m^2) and all black display in Measurement System A, and substitute them into the formula below.

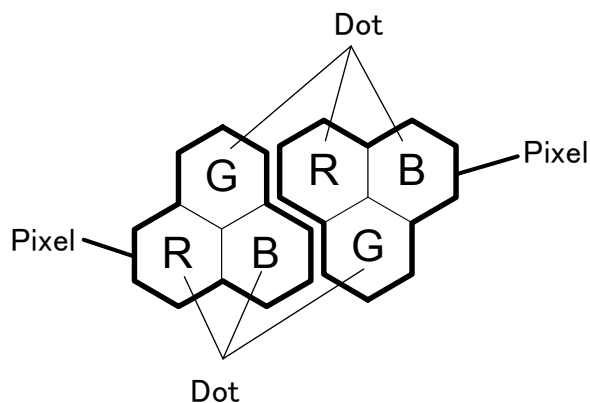
Contrast = Luminance in all white display / Luminance in all black display



Picture Quality Standards

1. Defect Standards

Item		Definition	Standard
Spot defect	Bright spot	When a dot is partially or completely luminous in all black display or RGB raster display	See "Bright Spot Standards" and "Dark Spot Standards."
	Dark spot	Defect in which whole pixel do not illuminate in all white display Dark spot whose size is less than 2×1 pixel ($2 \times 1 \text{ pixel} \geq$) is counted as a single defect.	
Spot defect Distance	Bright spot	Distance between bright dots	Horizontal 10 pixels or more and vertical 10 pixels or more
	Dark spot	Distance between dark pixels (single defect)	
Line defect	Bright line	Bright spots of continuous 2 dots or more	0
	Dark line	Dark lines of continuous 3 pixels or more	0



2. Uniformity Standard

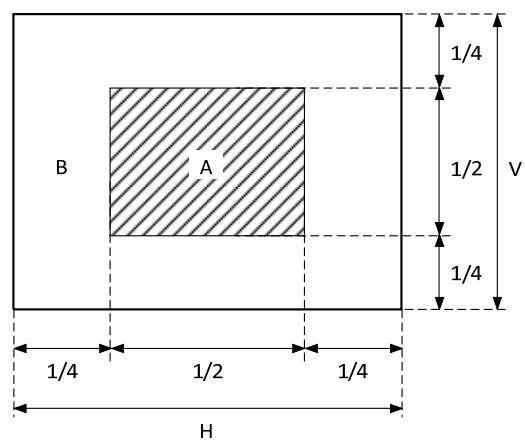
(Tpn1 = 40 °C)

Item	Definition	Standard
Uniformity	—	There should be no abnormality that impairs use. Separate discussions shall be held as necessary.
Stain		
String		
Roughness		

Appearance Standard

Item	Definition	Standard
Abnormality on panel	Uniformity within the effective display area, etc. Chipping and scratching outside of effective display area, etc.	There shall be no hindrance to actual use. Separate discussions shall be held as necessary. (Ignore abnormalities that cannot be checked in the picture quality inspection.)

Zone Definition



Bright Spot Standard

1. Judgment Criteria

Color	High-level bright spot	Low-level bright spot
G	$L \geq 20 \%$	$20 \% > L \geq 11 \%$
R	$L \geq 25 \%$	$25 \% > L \geq 11 \%$
B	$L \geq 80 \%$	$80 \% > L \geq 50 \%$

*L = (Bright spot luminance) ÷ (Monochrome raster luminance at white 200 cd/m²)

2. Number of Spots Standards

(All black display, single color raster display, T_{pnl} = 40 °C)

Zone	High-level bright spot	Low-level bright spot	High-level bright spot + Low-level bright spot
A	0	0	0
B	0	2	2
A+B	0	2	2

All White Bright Spot Standards

1. Judgment Criteria

Color	High-level bright spot	Low-level bright spot
G	$L \geq 200 \%$	$L < 200 \%$
R	$L \geq 200 \%$	$L < 200 \%$
B	$L \geq 300 \%$	$L < 300 \%$

*L = (Bright spot luminance) ÷ (Monochrome raster luminance at white 200 cd/m²)

2. Number of Spots Standards

(R, G and B monochromatic raster 100% display, T_{pnl} = 40 °C)

Zone	High-level bright spot	Low-level bright spot
A	0	Ignored
B	0	Ignored
A+B	0	Ignored

Dark Spot Standards

1. Judgment Criteria

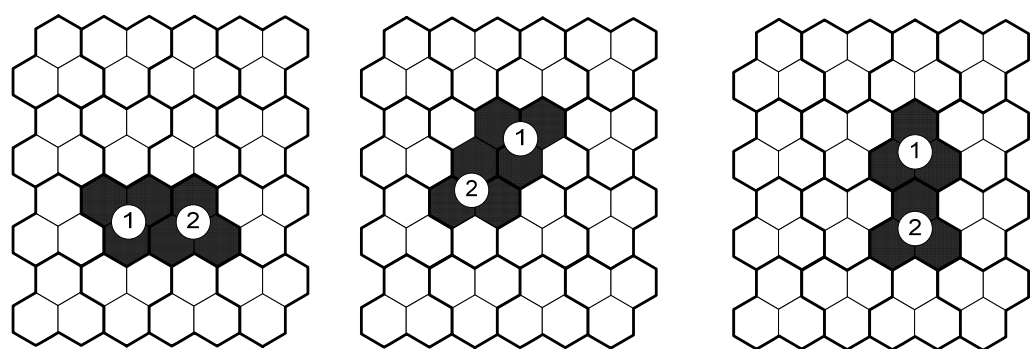
Dark spots are pixels with a luminance of $\leq 10\%$ in all white (200 cd/m^2) display.

2. Number of Spots Standards

(All white display, monochrome raster display, $T_{pnl} = 40 \text{ }^{\circ}\text{C}$)

Zone	$2 \times 1 \text{ pixel} \geq S \geq 1 \times 1 \text{ pixel}$	$S > 2 \times 1 \text{ pixel}$
A	1	0
B	3	0
A + B	4	0

S = Area of the dark spot



Examples of 2x1 pixel dark spot

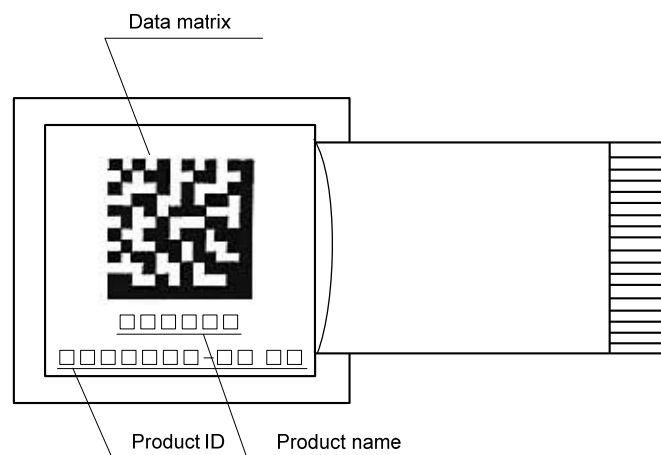
Environmental Test

Item		Specification	Judgment condition
Storage test	High temperature	85 °C 1000 h	There should be no remarkable deterioration in appearance and performance after the test.
	High temperature and high humidity	60 °C 90 % 1000 h	
	Low temperature	-30 °C 1000 h	
	Temperature cycle	-30 to 85 °C, Tdw 30 min, Ttr 5 min, 100 cyc	
Operation test	High temperature	70 °C 500 h	
	Temperature humidity bias	40 °C 95 % 500 h	
	Low temperature	-10 °C 500 h	
Strength test	Static charge	STM-0005 (HBM · CDM)	There should be no remarkable abnormality that impairs use in display appearance and panel appearance.
	Shock	980m/s ² , 6msec, ±X,Y,Z direction, 3 times	
	Vibration	20 min. in X, Y, Z direction, 5 to 50 Hz (random wave vibration)	

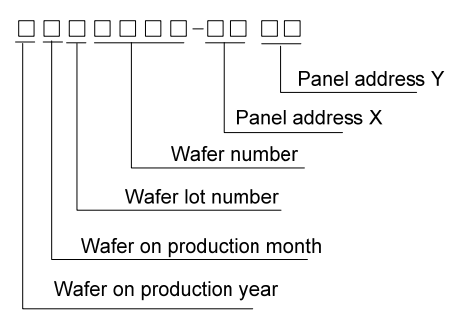
(Unit: mm)



Marking



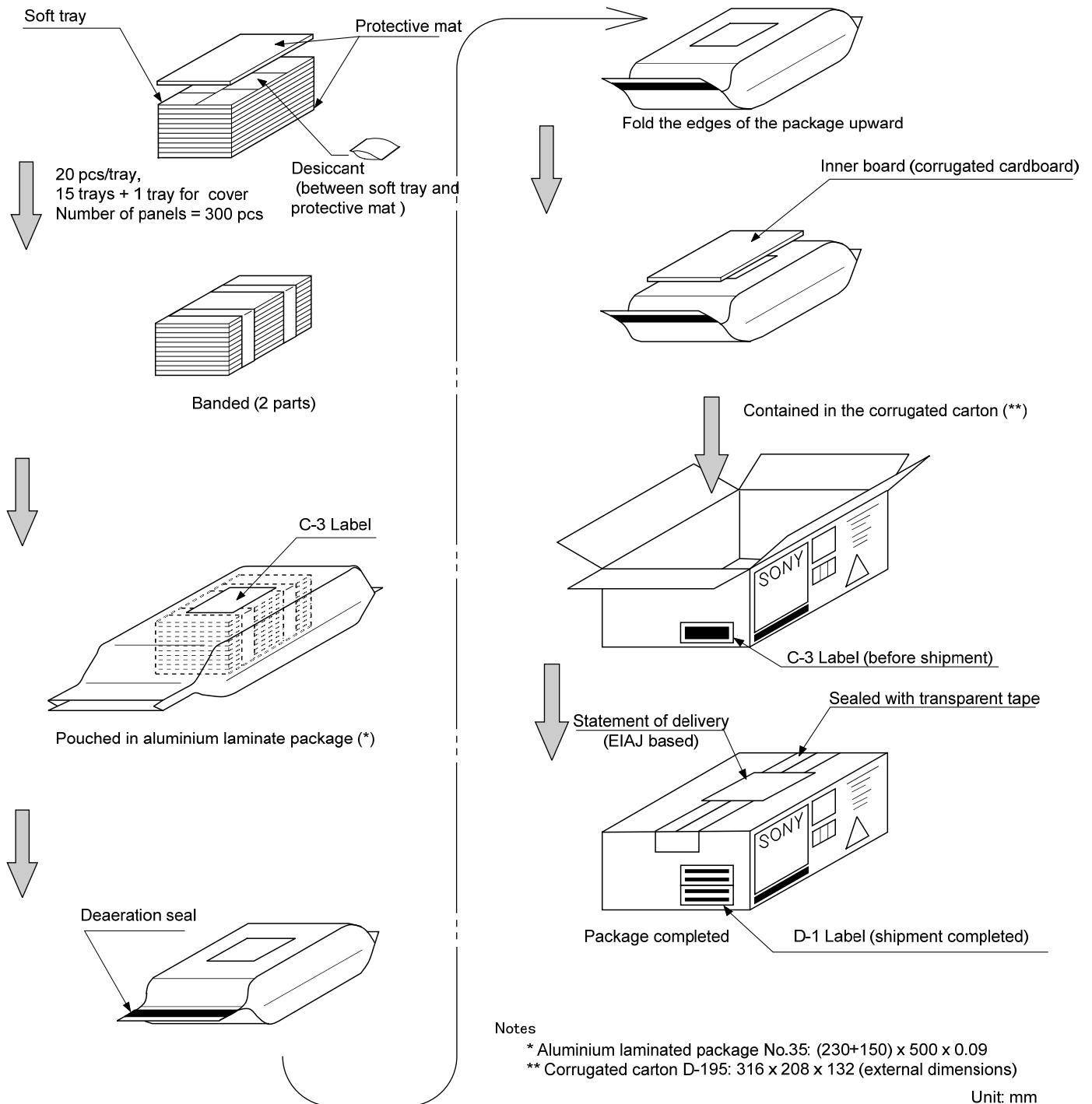
Product ID



Packing Specification

Format: Soft tray (capacity: 20 pcs)

Carton (Number of packing: 20 pcs × 15 tray = 300 pcs)

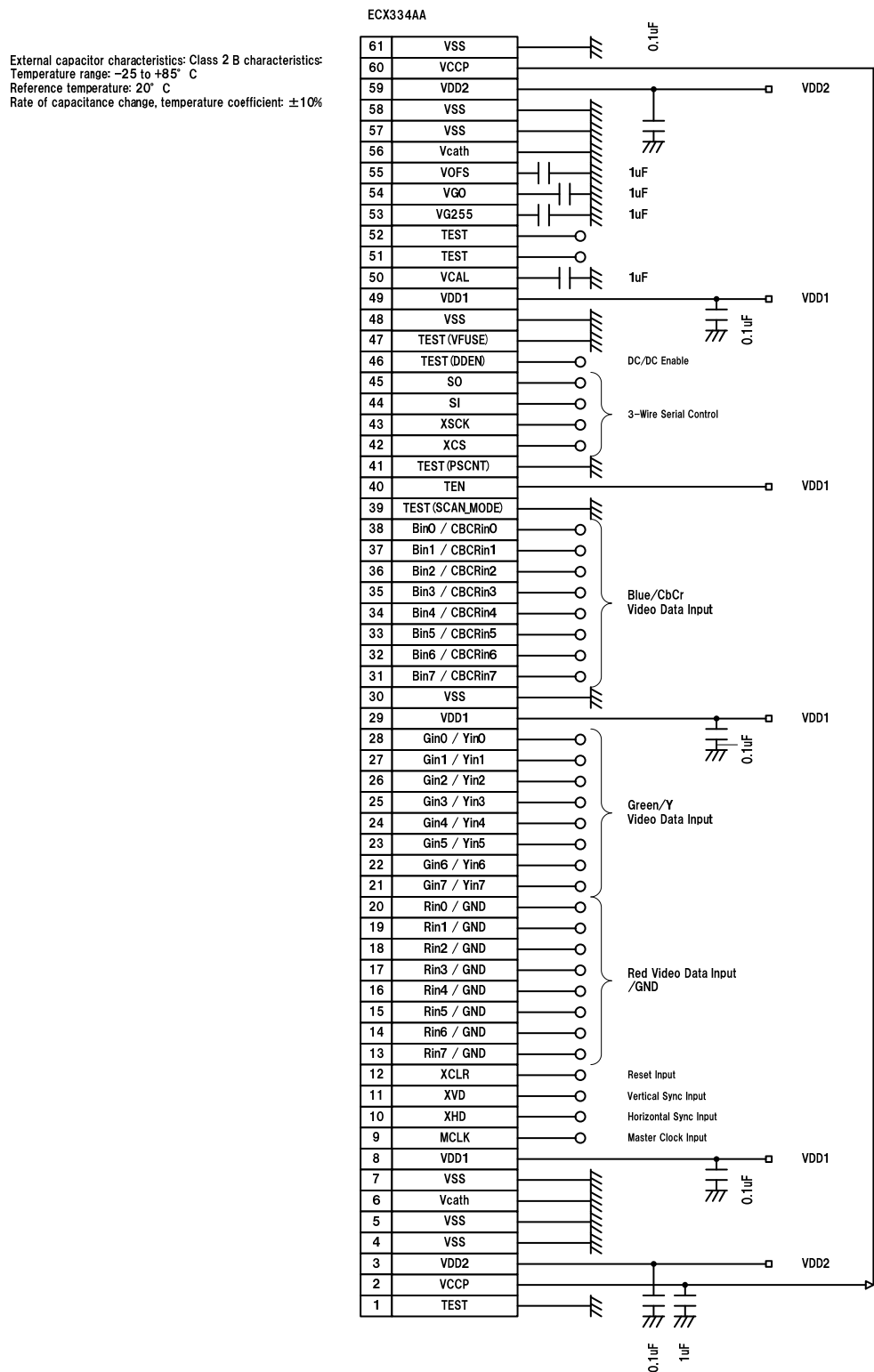


Recommended Items

1. Peripheral Circuits

The recommended peripheral circuits for the panel pins are shown below.

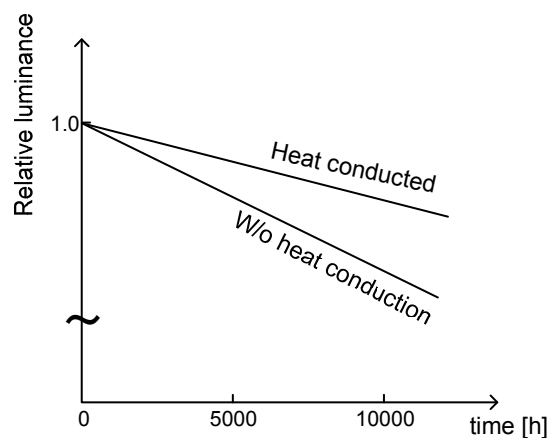
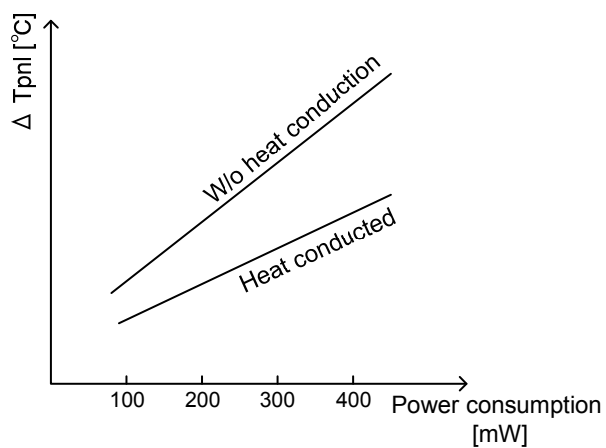
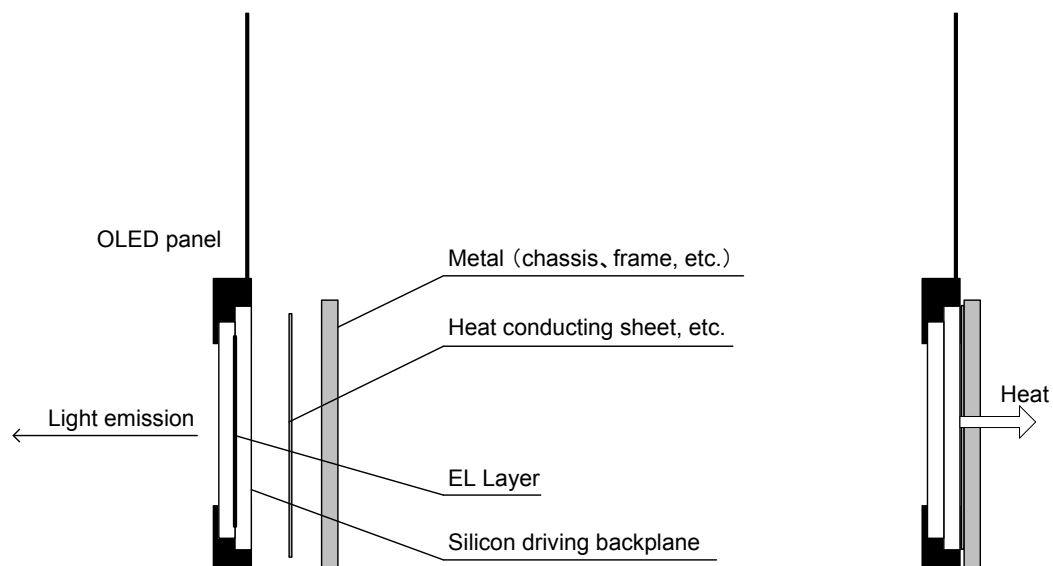
Regarding power supply capacitor connections, mount an approximately 2.2 μF to 10 μF capacitor for each power supply. Insufficient capacitance may affect the picture quality.



2. Suppression of the Panel Temperature

Organic EL panel temperatures rise due to power consumption (heat generation) by the EL emissive layer and the silicon drive board. A rise in the panel temperature may affect the drop in luminance over time.

The rise in panel temperature can be suppressed by establishing a thermal connection between the rear surface (silicon board surface) of the panel and metal (chassis, frame, etc.) in the panel mount area.



Notes on Handling

1. Static charge prevention

Be sure to take the following protective measures. Organic EL panels are easily damaged by static charges.

- (1) Use non-chargeable gloves, use bare hands.
- (2) Use a wrist strap when handling.
- (3) Do not touch any electrodes of the panel.
- (4) Wear non-chargeable clothes and conductive shoes.
- (5) Install grounded conductive mats on the working floor and working table.
- (6) Keep the panel away from any charged materials.

2. Protection from dust and dirt

- (1) Operate in a clean environment.
- (2) Do not touch the panel surface. The surface is easily scratched.
When cleaning, use a clean-room wiper with isopropyl alcohol. Be careful not to leave stains on the surface.
- (3) Use ionized air to blow dust off the panel surface.

3. Others

- (1) Do not hold the flexible board or twist or bend it because the flexible board connection block is easily affected by twisting.
- (2) The minimum fold radius of the flexible board is 1 mm.
- (3) Do not drop the panel.
- (4) Do not twist or bend the panel.
- (5) Keep the panel away from heat sources.
- (6) Do not dampen the panel with water or other solvents.
- (7) Do not store or use the panel (module) at high temperatures or high humidity, as this may affect the characteristics.
- (8) When disposing of this panel, handle it as industrial waste and comply with related regulations.
- (9) Do not store or use the panel in reactive chemical substance (including alcohol) environments, as this may affect the performance.
- (10) This panel is delivered packed in a degassed aluminum laminated bag.
When storing this panel after unsealing the bag, put it into the aluminum laminated bag again and seal it with tape with the opening folded after inserting desiccants.

Notice**Purpose of Use of the Products:**

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